

TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

**TC74HC161AP, TC74HC161AF, TC74HC161AFN**  
**TC74HC163AP, TC74HC163AF, TC74HC163AFN**

**SYNCHRONOUS PRESETTABLE 4 – BIT COUNTER**  
**TC74HC161AP/AF/AFN BINARY, ASYNCHRONOUS CLEAR**  
**TC74HC163AP/AF/AFN BINARY, SYNCHRONOUS CLEAR**

(Note) The JEDEC SOP (FN) is not available in Japan.

The TC74HC161A and 163A are high speed CMOS BINARY PRESETTABLE COUNTERS fabricated with silicon gate C<sup>2</sup>MOS technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation. The CK input is active on the rising edge. Both  $\overline{\text{LOAD}}$  and  $\overline{\text{CLR}}$  inputs are active on low logic level.

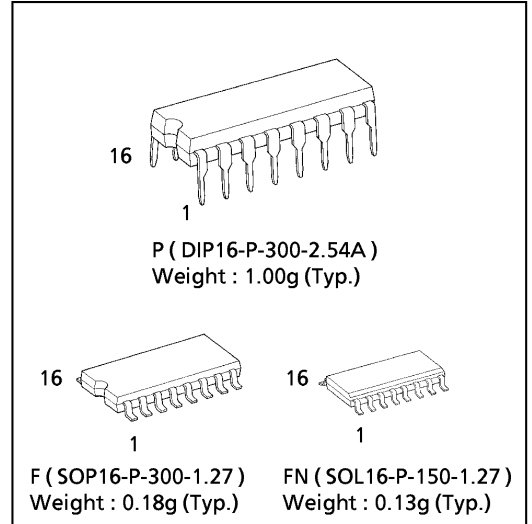
Presetting of all four IC's is synchronous to the rising edge of CK.

The clear function of the TC74HC163A is synchronous to CK, while the TC74HC161A is cleared asynchronously.

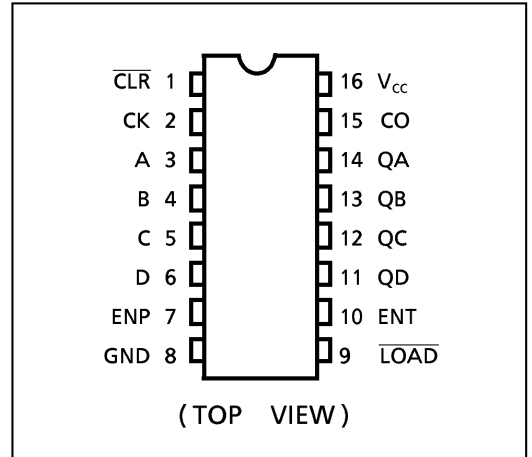
Two enable inputs (ENP and ENT) and CO are provided to enable easy cascading of counters, which facilitates easy implementation of n-bit counters without using external gates. All inputs are equipped with protection circuits against static discharge or transient excess voltage.

**FEATURES:**

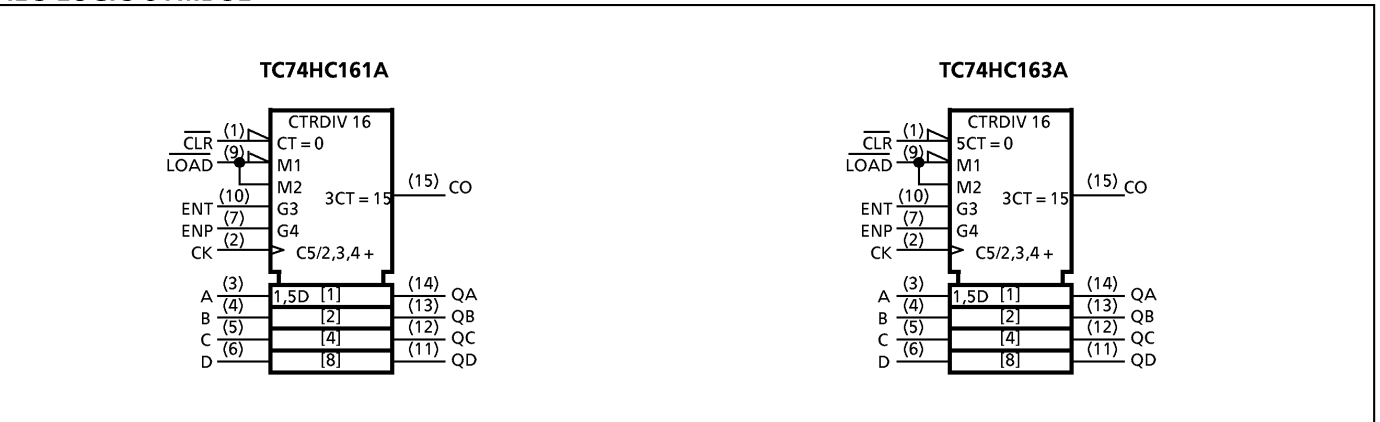
- High Speed.....  $f_{\text{MAX}} = 63\text{MHz}(\text{typ.})$  at  $V_{\text{CC}} = 5\text{V}$
- Low Power Dissipation.....  $I_{\text{CC}} = 4\mu\text{A}(\text{Max.})$  at  $T_a = 25^\circ\text{C}$
- High Noise Immunity.....  $V_{\text{NIH}} = V_{\text{NIL}} = 28\% V_{\text{CC}} (\text{Min.})$
- Output Drive Capability..... 10 LSTTL Loads
- Symmetrical Output Impedance...  $|I_{\text{OH}}| = |I_{\text{OL}}| = 4\text{mA}(\text{Min.})$
- Balanced Propagation Delays...  $t_{\text{pLH}} \approx t_{\text{pHL}}$
- Wide Operating Voltage Range...  $V_{\text{CC}} (\text{opr.}) = 2\text{V} \sim 6\text{V}$
- Pin and Function Compatible with 74LS161, 163



**PIN ASSIGNMENT**



**IEC LOGIC SYMBOL**

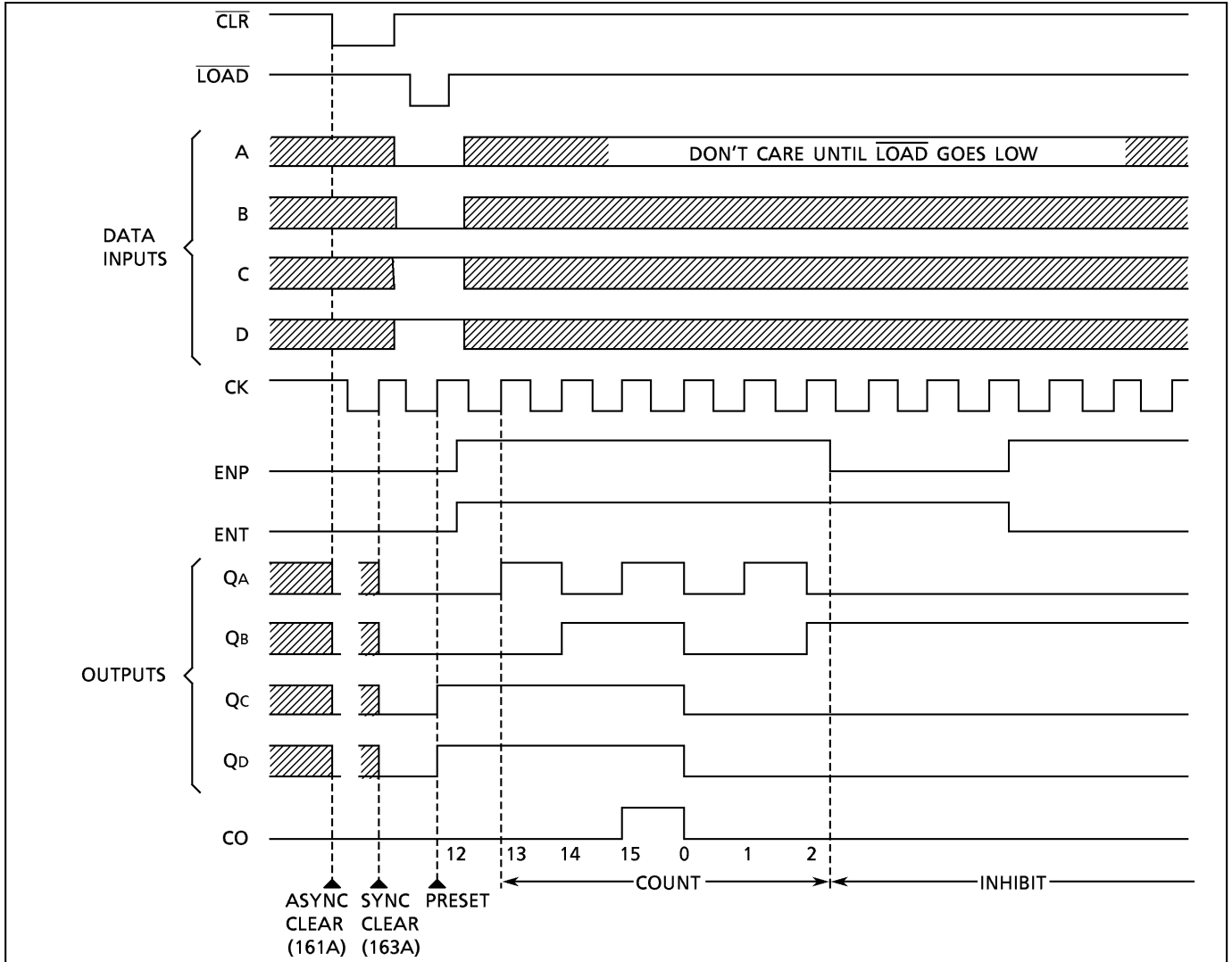


**TRUTH TABLE**

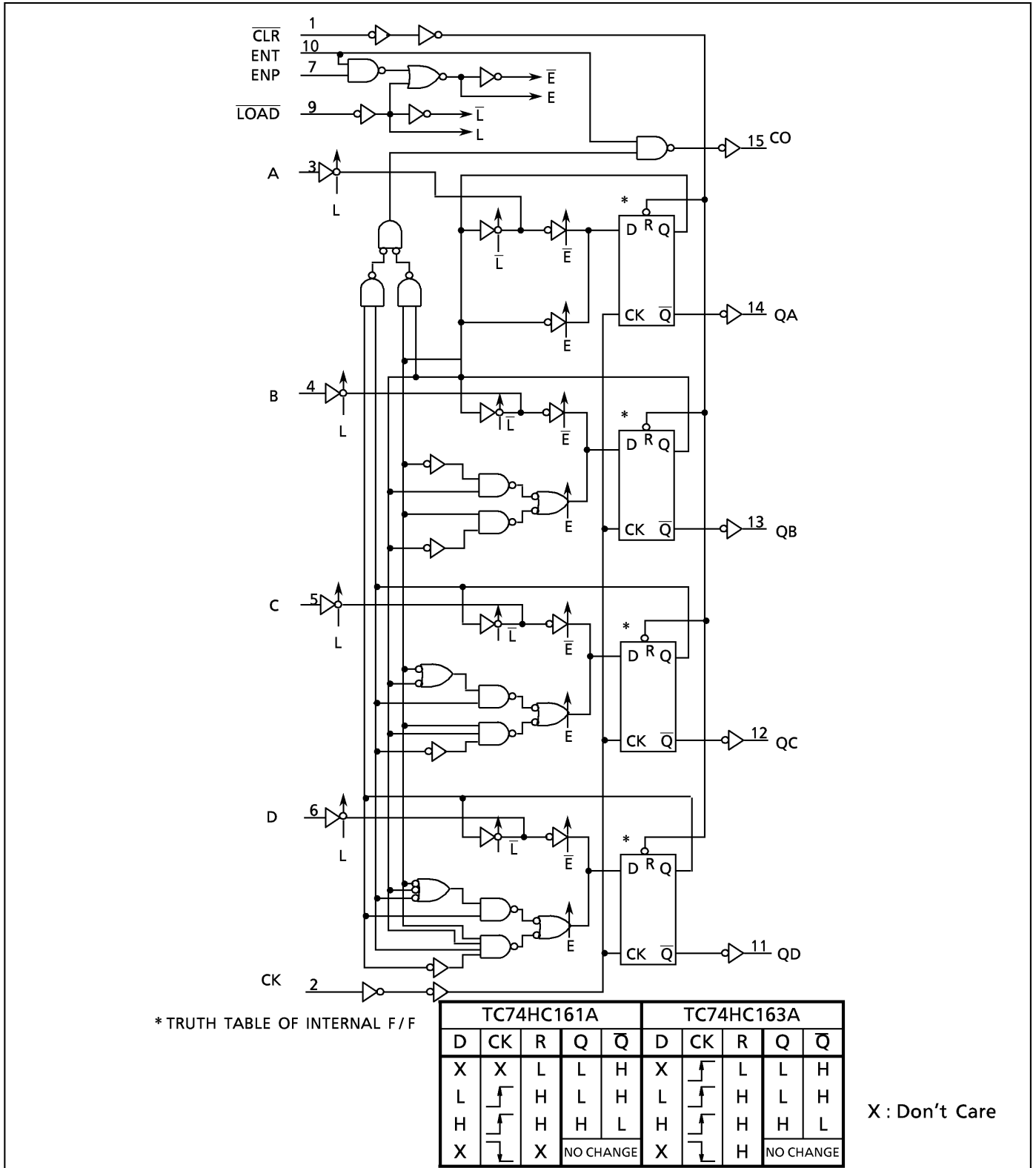
TC74HC161A					TC74HC163A					OUTPUTS				FUNCTION
INPUTS					INPUTS					QA	QB	QC	QD	
CLR	LD	ENP	ENT	CK	CLR	LD	ENP	ENT	CK	L	L	L	L	
L	X	X	X	X	L	X	X	X	↑	L	L	L	L	RESET TO "0"
H	L	X	X	↑	H	L	X	X	↑	A	B	C	D	PRESET DATA
H	H	X	L	↑	H	H	X	L	↑	NO CHANGE				NO COUNT
H	H	L	X	↑	H	H	L	X	↑	NO CHANGE				NO COUNT
H	H	H	H	↑	H	H	H	H	↑	COUNT UP				COUNT
H	X	X	X	↓	X	X	X	X	↓	NO CHANGE				NO COUNT

Note X : Don't Care  
 A, B, C, D : Logic Level of Data Inputs  
 Carry :  $CARRY = ENT \cdot QA \cdot QB \cdot QC \cdot QD$

**TIMING CHART**



SYSTEM DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	$V_{CC}$	-0.5~7	V
DC Input Voltage	$V_{IN}$	-0.5~ $V_{CC}+0.5$	V
DC Output Voltage	$V_{OUT}$	-0.5~ $V_{CC}+0.5$	V
Input Diode Current	$I_{IK}$	$\pm 20$	mA
Output Diode Current	$I_{OK}$	$\pm 20$	mA
DC Output Current	$I_{OUT}$	$\pm 25$	mA
DC $V_{CC}$ / Ground Current	$I_{CC}$	$\pm 50$	mA
Power Dissipation	$P_D$	500 (DIP)* / 180 (SOP)	mW
Storage Temperature	$T_{stg}$	-65~150	°C

\*500mW in the range of  $T_a = -40^\circ\text{C} \sim 65^\circ\text{C}$ . From  $T_a = 65^\circ\text{C}$  to  $85^\circ\text{C}$  a derating factor of  $-10\text{mW}/^\circ\text{C}$  shall be applied until 300mW.

## RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	$V_{CC}$	2~6	V
Input Voltage	$V_{IN}$	0~ $V_{CC}$	V
Output Voltage	$V_{OUT}$	0~ $V_{CC}$	V
Operating Temperature	$T_{opr}$	-40~85	°C
Input Rise and Fall Time	$t_r, t_f$	0~1000 ( $V_{CC} = 2.0\text{V}$ ) 0~500 ( $V_{CC} = 4.5\text{V}$ ) 0~400 ( $V_{CC} = 6.0\text{V}$ )	ns

## DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	$V_{CC}$ (V)	$T_a = 25^\circ\text{C}$			$T_a = -40 \sim 85^\circ\text{C}$		UNIT	
				MIN.	TYP.	MAX.	MIN.	MAX.		
High - Level Input Voltage	$V_{IH}$		2.0	1.50	—	—	1.50	—	V	
			4.5	3.15	—	—	3.15	—		
			6.0	4.20	—	—	4.20	—		
Low - Level Input Voltage	$V_{IL}$		2.0	—	—	0.50	—	0.50	V	
			4.5	—	—	1.35	—	1.35		
			6.0	—	—	1.80	—	1.80		
High - Level Output Voltage	$V_{OH}$	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OH} = -20\mu\text{A}$	2.0	1.9	2.0	—	1.9	—	V
				4.5	4.4	4.5	—	4.4	—	
			$I_{OH} = -4\text{ mA}$ $I_{OH} = -5.2\text{ mA}$	4.5	4.18	4.31	—	4.13	—	
				6.0	5.68	5.80	—	5.63	—	
Low - Level Output Voltage	$V_{OL}$	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL} = 20\mu\text{A}$	2.0	—	0.0	0.1	—	0.1	V
				4.5	—	0.0	0.1	—	0.1	
			$I_{OL} = 4\text{ mA}$ $I_{OL} = 5.2\text{ mA}$	4.5	—	0.17	0.26	—	0.33	
				6.0	—	0.18	0.26	—	0.33	
Input Leakage Current	$I_{IN}$	$V_{IN} = V_{CC}$ or GND	6.0	—	—	$\pm 0.1$	—	$\pm 1.0$	$\mu\text{A}$	
Quiescent Supply Current	$I_{CC}$	$V_{IN} = V_{CC}$ or GND	6.0	—	—	4.0	—	40.0		

**TIMING REQUIREMENTS (Input  $t_r = t_f = 6ns$ )**

PARAMETER	SYMBOL	TEST CONDITION	$V_{CC}$ (V)	Ta = 25°C		Ta = -40~85°C	UNIT
				TYP.	LIMIT	LIMIT	
Minimum Pulse Width (CK)	$t_{W(H)}$ $t_{W(L)}$	Fig. 1	2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Minimum Pulse Width (CLR)*	$t_{W(L)}$	Fig. 4	2.0	—	75	95	
			4.5	—	15	19	
			6.0	—	13	16	
Minimum Set-up Time (LOAD, ENP, ENT)	$t_s$	Fig. 2, 3	2.0	—	100	125	
			4.5	—	20	25	
			6.0	—	17	21	
Minimum Set-up Time (A, B, C, D)	$t_s$	Fig. 2	2.0	—	75	95	
			4.5	—	15	19	
			6.0	—	13	16	
Minimum Set-up Time (CLR)**	$t_s$	Fig. 5	2.0	—	75	95	
			4.5	—	15	19	
			6.0	—	13	16	
Minimum Hold Time	$t_h$	Fig. 2, 3, 5	2.0	—	0	0	
			4.5	—	0	0	
			6.0	—	0	0	
Minimum Removal Time (CLR)*	$t_{rem}$	Fig. 4	2.0	—	50	65	
			4.5	—	10	13	
			6.0	—	9	11	
Clock Frequency	f		2.0	—	6	5	MHz
			4.5	—	31	25	
			6.0	—	36	29	

**AC ELECTRICAL CHARACTERISTICS ( $C_L = 15pF$ ,  $V_{CC} = 5V$ , Ta = 25°C, Input  $t_r = t_f = 6ns$ )**

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Transition Time	$t_{TLH}$ $t_{THL}$	Fig. 1	—	4	8	ns
Propagation Delay Time (CK-Q)	$t_{pLH}$ $t_{pHL}$	Fig. 1	—	13	21	
Propagation Delay Time (CK-CO) [Count Mode]	$t_{pLH}$ $t_{pHL}$	Fig. 1	—	16	26	
Propagation Delay Time (CK-CO) [Preset Mode]	$t_{pLH}$	Fig. 2	—	18	30	
	$t_{pHL}$		—	20	35	
Propagation Delay Time (ENT-CO)	$t_{pLH}$ $t_{pHL}$	Fig. 6	—	10	17	
Propagation Delay Time (CLR-Q)*	$t_{pHL}$	Fig. 4	—	17	26	
Propagation Delay Time (CLR-CO)*	$t_{pHL}$	Fig. 4	—	20	35	
Maximum Clock Frequency	$f_{MAX}$		36	63	—	MHz

\*: for TC74HC161A only

\*\* : for TC74HC163A only

**AC ELECTRICAL CHARACTERISTICS ( C<sub>L</sub> = 50pF, Input t<sub>r</sub> = t<sub>f</sub> = 6ns )**

PARAMETER	SYMBOL	TEST CONDITION	V <sub>CC</sub> (V)	Ta = 25°C			Ta = -40~85°C		UNIT
				MIN.	TYP.	MAX.	MIN.	MAX.	
Output Transition Time	t <sub>TLH</sub> t <sub>THL</sub>		2.0	—	25	75	—	95	ns
			4.5	—	7	15	—	19	
			6.0	—	6	13	—	16	
Propagation Delay Time (CK—Q)	t <sub>PLH</sub> t <sub>PHL</sub>	Fig. 1	2.0	—	48	125	—	155	
			4.5	—	16	25	—	31	
			6.0	—	14	21	—	26	
Propagation Delay Time (CK—CO) [Count Mode]	t <sub>PLH</sub> t <sub>PHL</sub>	Fig. 1	2.0	—	57	150	—	190	
			4.5	—	19	30	—	38	
			6.0	—	16	26	—	33	
Propagation Delay Time (CK—CO) [Preset Mode]	t <sub>PLH</sub>	Fig. 2	2.0	—	66	175	—	220	
			4.5	—	22	35	—	44	
			6.0	—	19	30	—	37	
	t <sub>PHL</sub>		2.0	—	72	200	—	250	
			4.5	—	24	40	—	50	
			6.0	—	20	34	—	43	
Propagation Delay Time (ENT—CO)	t <sub>PLH</sub> t <sub>PHL</sub>	Fig. 6	2.0	—	39	100	—	125	
			4.5	—	13	20	—	25	
			6.0	—	11	17	—	21	
Propagation Delay Time (CLR—Q)*	t <sub>PHL</sub>	Fig. 4	2.0	—	60	150	—	190	
			4.5	—	20	30	—	38	
			6.0	—	17	26	—	33	
Propagation Delay Time (CLR—CO)*	t <sub>PHL</sub>	Fig. 4	2.0	—	72	200	—	250	
			4.5	—	24	40	—	50	
			6.0	—	20	34	—	43	
Maximum Clock Frequency	f <sub>MAX</sub>		2.0	6	18	—	5	—	MHz
			4.5	31	53	—	25	—	
			6.0	36	62	—	29	—	
Input Capacitance	C <sub>IN</sub>			—	5	10	—	10	pF
Power Dissipation Capacitance	C <sub>PD</sub> (1)			—	34	—	—	—	

Note (1) C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation :

$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

When the outputs drive a capacitive load, total current consumption is the sum of C<sub>PD</sub>, and ΔI<sub>CC</sub> which is obtained from the following formula :

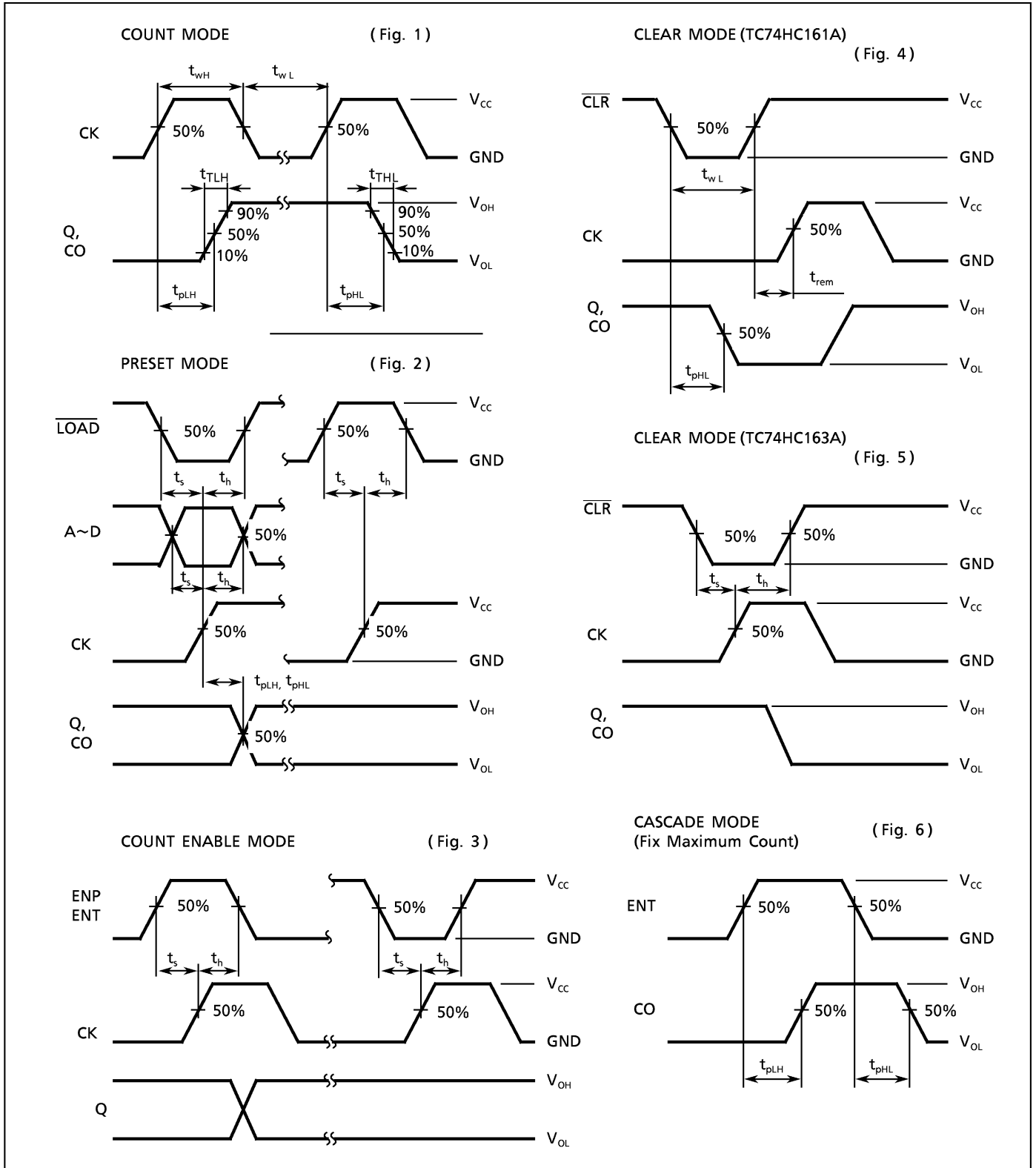
In case of TC74HC161A / 163A :

$$\Delta I_{CC} = f_{CK} \cdot V_{CC} \left( \frac{C_{QA}}{2} + \frac{C_{QB}}{4} + \frac{C_{QC}}{8} + \frac{C_{QD}}{16} + \frac{C_{CO}}{16} \right)$$

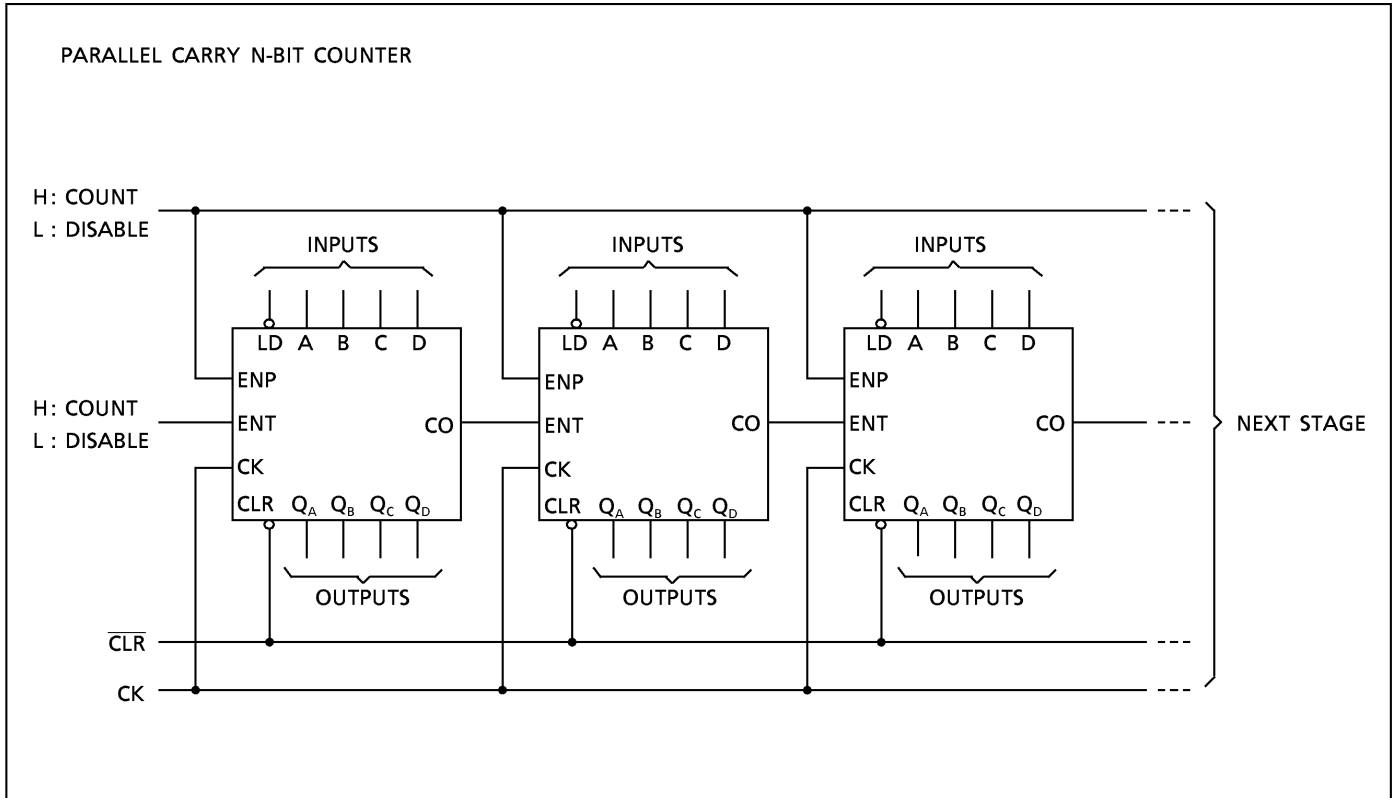
C<sub>QA</sub>~C<sub>QD</sub> and C<sub>CO</sub> are the capacitances at QA~QD and CO, respectively.  
f<sub>CK</sub> is the input frequency of the CK.

\* for TC74HC161A only

SWITCHING CHARACTERISTICS TEST WAVEFORM



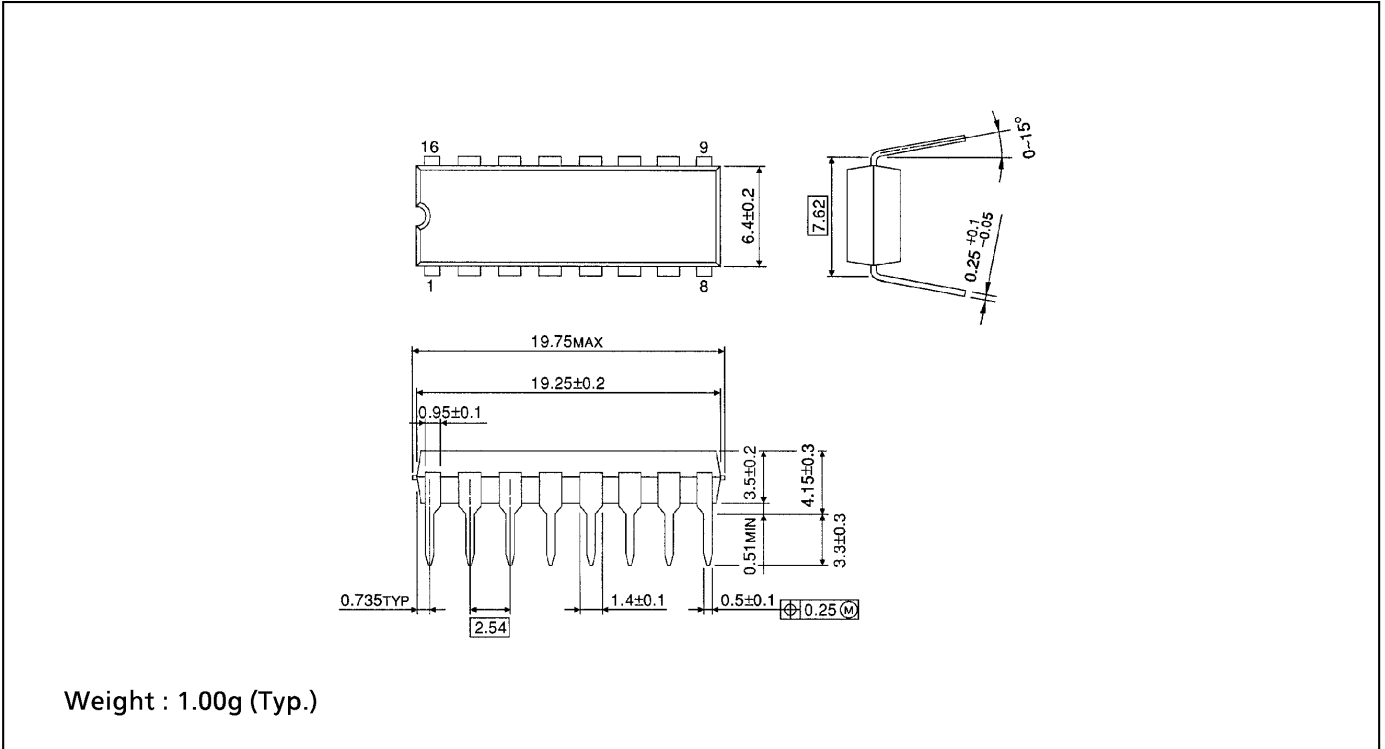
**TYPICAL APPLICATION**





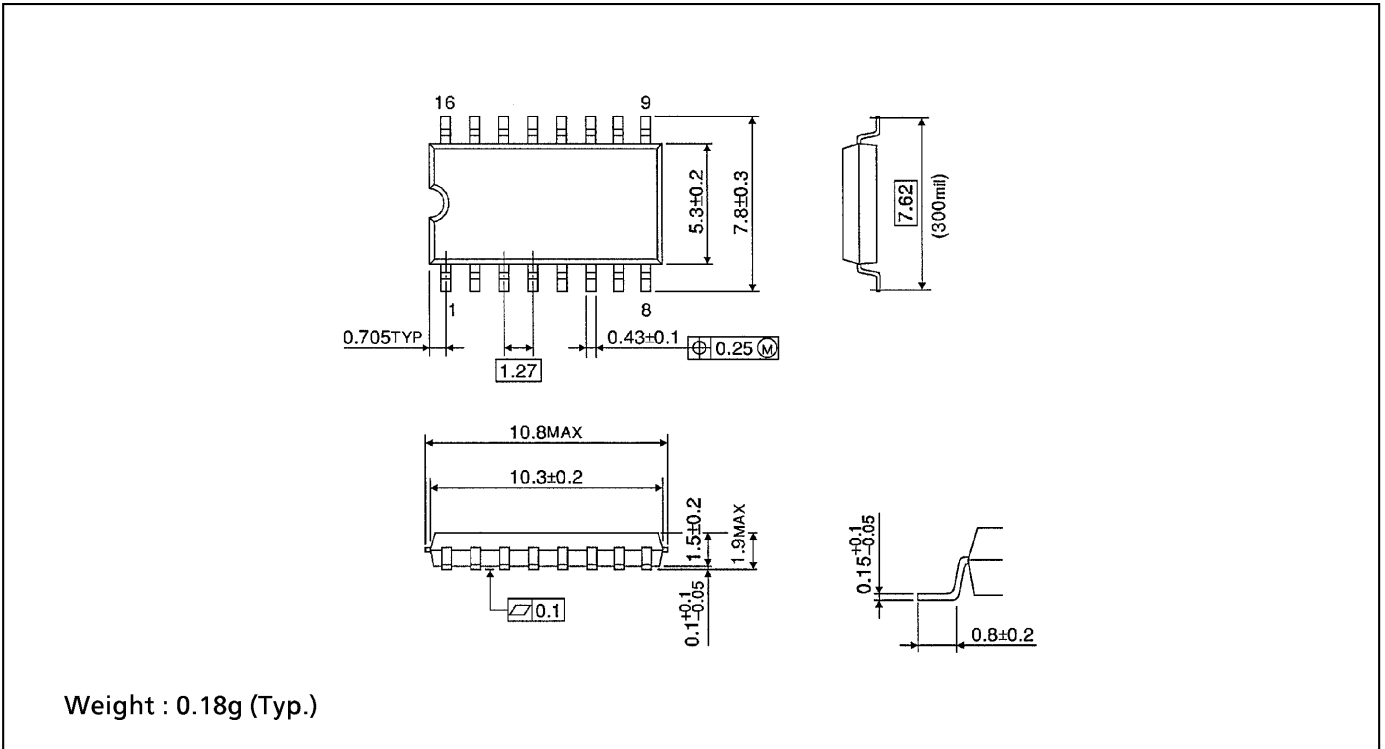
**DIP 16PIN PACKAGE DIMENSIONS (DIP16-P-300-2.54A)**

Unit in mm



**SOP 16PIN (200mil BODY) PACKAGE DIMENSIONS (SOP16-P-300-1.27)**

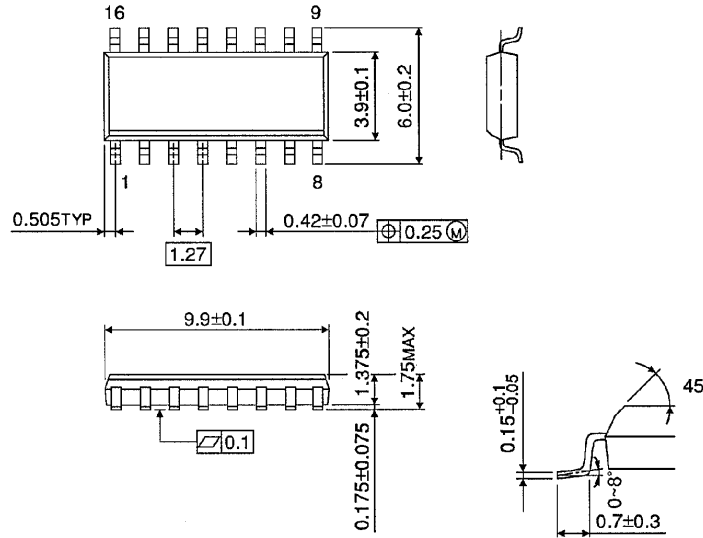
Unit in mm



**SOP 16PIN ( 150mil BODY ) PACKAGE DIMENSIONS (SOL16-P-150 -1.27)**

Unit in mm

(Note) This package is not available in Japan.



Weight : 0.13g (Typ.)

**RESTRICTIONS ON PRODUCT USE**

000707EBA

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- The products described in this document are subject to the foreign exchange and foreign trade laws.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.